

PolarHT[™] Power MOSFET

IXTK 120N20P IXTQ 120N20P

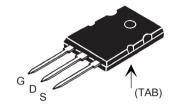
 $V_{DSS} = 200 V$ $I_{D25} = 120 A$ $R_{DS(on)} \le 22 m\Omega$

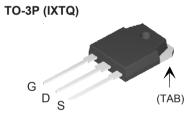
N-Channel Enhancement Mode Avalanche Rated



TO-264 (IXTK)

Symbol	Test Conditions		Maxim	um Ra	tings
V _{DSS} V _{DGR}	$T_J = 25^{\circ}$ C to 175° C $T_J = 25^{\circ}$ C to 175° C; $R_{GS} = 1$ MΩ			00 00	V V
V_{gs}	Continuous		<u>±</u>	20	V
V _{GSM}	Transient		±	30	V
I _{D25}	T _C =25°C		1.	20	Α
I _{D(RMS)}	External lead current limit			75	Α
I _{DM}	$T_{\rm C} = 25^{\circ}$ C, pulse width limited by $T_{\rm JM}$		3	00	Α
I _{AR}	T _C =25°C			60	Α
E _{AR}	T _C = 25° C			60	mJ
E _{AS}	T _C = 25° C		2	2.0	J
dv/dt	$I_{S} \leq I_{DM}$, di/dt \leq 100 A/ μ s, $V_{DD} \leq V_{DSS}$, $T_{J} \leq$ 175° C, $R_{G} = 4 \Omega$			10	V/ns
$\overline{P_{D}}$	T _C = 25° C		7	14	W
T _J		-!	55 +1	75	°C
T_JM			1	75	°C
T_{stg}		-{	55 +1	75	°C
T _L T _{SOLD}	1.6 mm (0.062 in.) from case for 10 s Plastic body for 10 s			00 60	°C °C
M _d	Mounting torque		1.13/	10 Nn	n/lb.in.
Weight	TO-3P TO-264			5.5 10	g g
Symbol $(T_J = 25^{\circ} C, t)$	Test Conditions unless otherwise specified)	Ch Min.	aracter Typ.	istic Va Ma	
BV _{DSS}	V _{GS} = 0 V, I _D = 250 μA	200			V
V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250\mu A$	2.5		5.0	V
I _{GSS}	$V_{GS} = \pm 20 V_{DC}, V_{DS} = 0$			±100	nA
I _{DSS}	$V_{DS} = V_{DSS}$ $V_{GS} = 0 V$ $T_{J} = 175^{\circ} C$			25 500	μA μA





G = Gate D = DrainS = Source TAB = Drain

Features

- ¹ International standard packages
- Unclamped Inductive Switching (UIS) rated
- Low package inductance
 - easy to drive and to protect

Advantages

 $22 m\Omega$

- Easy to mount
- Space savings
- High power density

 $V_{GS} = 10 \text{ V}, I_{D} = 0.5 I_{D25}$

Pulse test, t \leq 300 μ s, duty cycle d \leq 2 %

 $\boldsymbol{R}_{\text{DS(on)}}$



Symbo		ess othe	erwise specified) Max.
g _{fs}	$V_{DS} = 10 \text{ V; } I_{D} = 0.5 I_{D25}, \text{ pulse test}$ 4		
C _{iss})	600	0 pF
C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	130	0 pF
\mathbf{C}_{rss})	26	5 pF
t _{d(on)})	3	0 ns
t,	$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 V_{DSS}, I_{D} = I_{D25}$	3	5 ns
$\mathbf{t}_{d(off)}$	$R_{\rm G} = 3.3 \Omega (\text{External})$	10	0 ns
t _f)	3	1 ns
Q _{g(on)})	15	2 nC
Q _{gs}	$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 V_{DSS}, I_{D} = 0.5 I_{D25}$	4	0 nC
\mathbf{Q}_{gd})	7	5 nC
R _{thJC}			0.21° C/W
$\mathbf{R}_{\mathrm{thCS}}$	TO-3P	0.2	1 ° C/W
R _{thCs}	TO-264	0.1	5 ° C/W

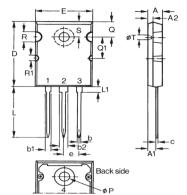
Source-Drain Diode

Characteristic Values

(T_J = 25° C, unless otherwise specified)

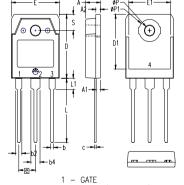
Symbol	Test Conditions	Min.	Тур.	Max.	
I _s	$V_{GS} = 0 V$			120	Α
I _{SM}	Repetitive			300	Α
V _{SD}	$I_F = I_S$, $V_{GS} = 0$ V, Pulse test, t ≤300 μ s, duty cycle d≤ 2 %			1.5	V
t _{rr} Q _{RM}	$\begin{cases} I_{F} = 25 \text{ A, } -\text{di/dt} = 100 \text{ A/}\mu\text{s} \\ V_{R} = 100 \text{ V, } V_{GS} = 0 \text{ V} \end{cases}$		180 3.0		ns μC

TO-264 (IXTK) Outline



Dim.	Millimeter		Inches		
	Min.	Max.	Min.	Max.	
Α	4.82	5.13	.190	.202	
A1	2.54	2.89	.100	.114	
A2	2.00	2.10	.079	.083	
b	1.12	1.42	.044	.056	
b1	2.39	2.69	.094	.106	
b2	2.90	3.09	.114	.122	
С	0.53	0.83	.021	.033	
D	25.91	26.16	1.020	1.030	
Е	19.81	19.96	.780	.786	
е	5.46 BSC		.215 BSC		
J	0.00	0.25	.000	.010	
K	0.00	0.25	.000	.010	
L	20.32	20.83	.800	.820	
L1	2.29	2.59	.090	.102	
Р	3.17	3.66	.125	.144	
Q	6.07	6.27	.239	.247	
Q1	8.38	8.69	.330	.342	
R	3.81	4.32	.150	.170	
R1	1.78	2.29	.070	.090	
S	6.04	6.30	.238	.248	

TO-3P (IXTQ) Outline



1 - GATE 2 - DRAIN (COLLECTOR) 3 - SOURCE (EMITTER) 4 - DRAIN (COLLECTOR)

SYM	INCHES		MILLIMETERS	
STIVI	MIN	MAX	MIN	MAX
Α	.185	.193	4.70	4.90
A1	.051	.059	1.30	1.50
A2	.057	.065	1.45	1.65
Ь	.035	.045	0.90	1.15
b2	.075	.087	1.90	2.20
b4	.114	.126	2.90	3.20
С	.022	.031	0.55	0.80
D	.780	.799	19.80	20.30
D1	.665	.677	16.90	17.20
E	.610	.622	15.50	15.80
E1	.531	.539	13.50	13.70
е	.215 BSC		5.45 BSC	
L	.779	.795	19.80	20.20
L1	.134	.142	3.40	3.60
ØΡ	.126	.134	3.20	3.40
øP1	.272	.280	6.90	7.10
S	.193	.201	4.90	5.10

IXYS reserves the right to change limits, test conditions, and dimensions.

Fig. 1. Output Characteristics
@ 25°C

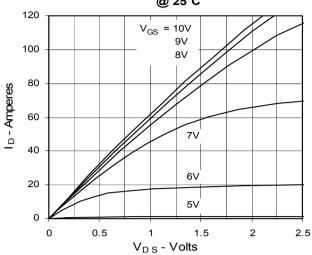


Fig. 3. Output Characteristics

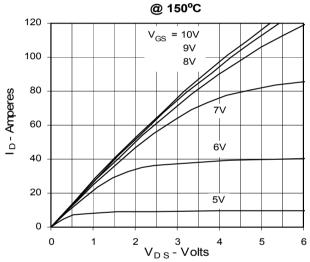


Fig. 5. $R_{DS(on)}$ Normalized to 0.5 I_{D25} Value vs. Drain Current

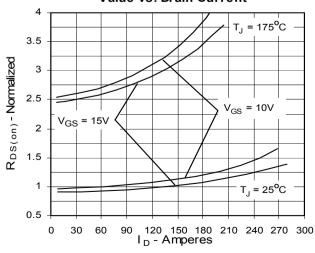


Fig. 2. Extended Output Characteristics

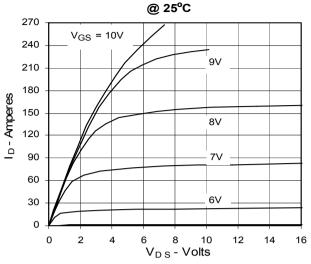


Fig. 4. $R_{DS(on)}$ Normalized to 0.5 I_{D25} Value vs. Junction Temperature

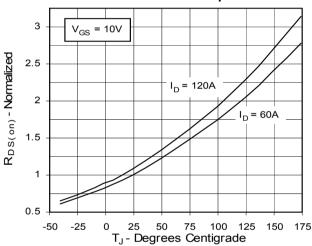
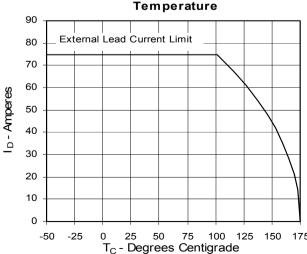


Fig. 6. Drain Current vs. Case Temperature



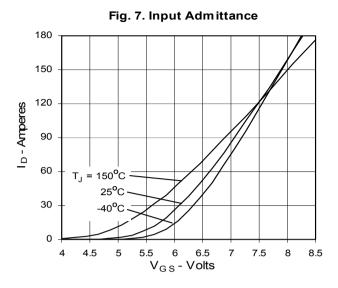
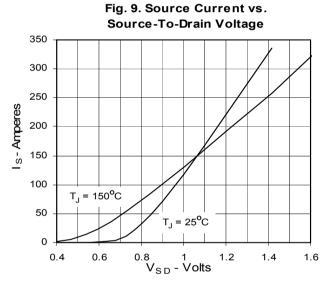
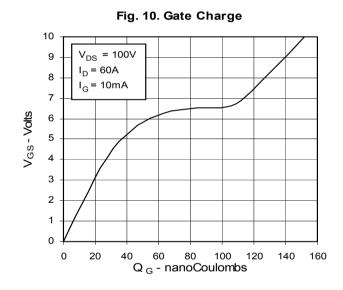
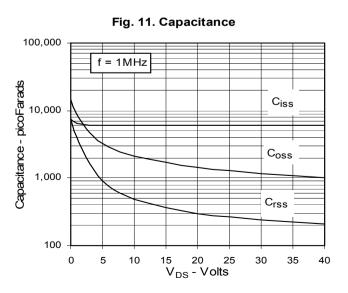
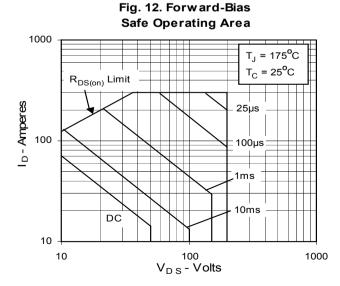


Fig. 8. Transconductance gfs-Siemens = -40°C 25°C 150°C I_D - Amperes









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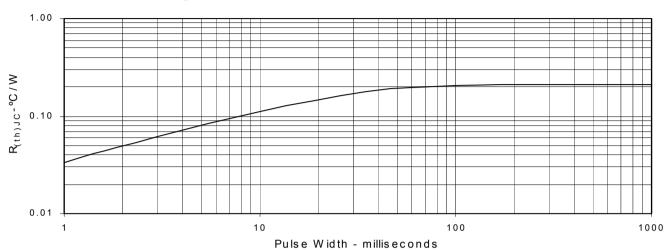


Fig. 13. Maximum Transient Thermal Resistance

